18 Je		SHEET 1 OF 1	
FORM BYO 1449 U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE INFERIMATION DISCLOSURE STATEMENT	ATTY, DOCKET NO. IMEC280:001AUS	APPLICATION NO. 10/821,044	
BY APPLICANT  OUSE SEVERAL SHEETS IF NECESSARY)	APPLICANT Collaert, et al.		
(USE SEVERAL SHEETS IF NECESSARY)	FILING DATE July 15, 2003	GROUP 2814- 2923	

U.S. PATENT DOCUMENTS							
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS.	FILING DATE (IF APPROPRIATE)
T.3	1	6,118,161	09/12/00	Chapman, et al.			7
Q. T	2	6,207,511	03/27/01	Chapman, et al.	~		
C. T	3	6,252,284 B1	06/26/01	Muller, et al.	~		

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